

Surfaces & Interfaces (II) [Millis]

- We shall consider explicitly superlattice of perovskite ABO_3

▲ perovskite :
A sits on corner of cubic lattice
B sits on center of cubic lattice
O sits on the faces of cubic lattice

▲ We shall assume B transition metal, & A = La, Sr, ...

▲ The general superlattice is 001 (along cubic axis)

- Homometallic : "A" changes, "B" stays the same

e.g. $\text{LaTiO}_3 / \text{SrTiO}_3$

- Heterometallic : "B" changes ("A" may or may not change)

case A: hard wall, e.g.

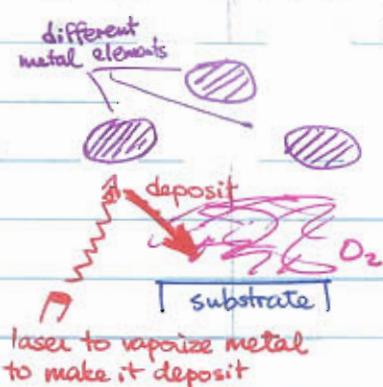
case B: different correlated material, e.g. $\text{LaMnO}_3 / \text{YBa}_2\text{Cu}_3\text{O}_7$

- Fabrication methods (all variation on film)

▲ Oxide epitaxy

▲ MBE

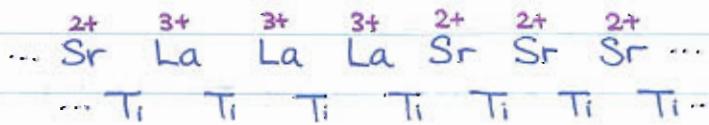
▲ Pulsed Laser Deposition



- Image can be obtained because different atoms have different cross sections.

▲ But reality is often less "clean & clean" than the image suggests.

- Consider



naive: 0.5 1 1 0.5 0 0 0

▲ LaTiO_3 is Mott insulator, SrTiO_3 is band insulator

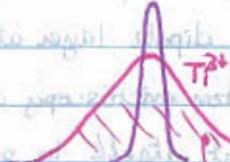
- The charge distribution can be measured by TEM/EELS

► look for inelastic processes, in particular:



probability depends on what's already in d-shell.

► The Ti state with (say) +0.5 charge can be decompose into superposition of +0 & +1 charge (not clear why, with square sum it is just superposition)

► Result:  Ti³⁺ density integrated out to 1 per La

→ negligible oxygen vacancy.

► One can also measure longitudinal Hall resistance to find carrier density

► Get ~2/3 carrier per La naively. Still close to ~1 as expected.

► Now it is also possible to do optical measurement (red peak)

► In above TEM can truly resolve individual layer, while Hall probe/optical measure involve averaging between layers.

• Magnetization can be seen at interface

• Consider LaMnO₃/YBa₂Cu₃O₇:

► Orbital occupation can be measured using polarized light.

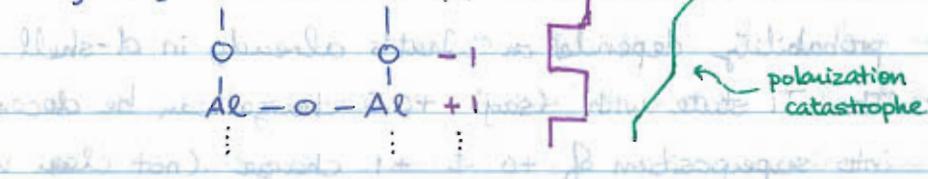
► Bulk: holes found in $|x^2 - y^2\rangle$ state

Interface: holes found ALSO in $|3z^2 - r^2\rangle$ state.

- Consider electrostatics of these superlattice

- Most ABO_3 perovskite are polar \Rightarrow charges build up at termination of interface

e.g. LaAlO_3 $\text{Al} - \text{O} - \text{Al}$



- Intuitively, this is why from material science perspective, for thicker polar layer in superlattice, quality of interface reduces.

- To cure, introduce dipole layer at the end: $\text{C}: \frac{1}{2} - 1 + 1 \dots - 1 + \frac{1}{2}$
- This is why electron microscopy is hard to do in these materials, since the interface adjust itself to produce the desired polar charge.

- Sawatzky insight is that in superlattice, the $\pm \frac{1}{2}$ charge layer can be obtained by having an 2D e^- gas in the interface (hence interface \Rightarrow more metallic).

- Question: Do we have ion transfer or e^- transfer?

- For $\text{SrTiO}_3 / \text{LaAlO}_3$, we have p-type & n-type

p-type: $\dots \text{Ti} \overset{\frac{1}{2}}{\text{Sr}} \overset{+1}{\text{Al}} \overset{-1}{\text{La}}$

n-type: $\text{Sr} \overset{-\frac{1}{2}}{\text{Ti}} \overset{+1}{\text{La}} \overset{-1}{\text{Al}}$

- For n-type find $\sim 0.6 e^-$ & ~ 0.15 O vacancy

- For p-type find $\sim 0.6 e^-$ & ~ 0.3 O vacancy

\Rightarrow for some reason the material does not want to dope interface with holes.

- Heterometallic interface is less sharp than homometallic

- For $\text{LaAlO}_3 / \text{SrTiO}_3$, the interface goes superconducting,

but mobile carrier ~ 0.1 per cell.

- Similarly, Hall measurement shows fewer mobile carriers

[unintelligible] (II) ~~neglecting~~ ~~neglect~~ ~~X~~ & ~~neglect~~

- SrTiO_3 is a bulk SC, but can only support few carriers.
Matching \Rightarrow can get interface SC up to 16 layers.

$J_{\text{dipole}} \leftarrow$ equal dipole energy - ~~and total~~ $\Delta V = \frac{2\pi e^2}{Ec} (1-2n) N$

- Consider $\text{LaAlO}_3/\text{SrTiO}_3$

$$E_0 = n\Delta + \frac{1}{2} E_{\text{comp}} n^2$$

the solving places right, ~~atmosphere~~ ~~at the beginning of~~ ~~it don't~~

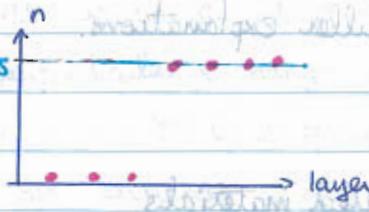
At the other surface we need (surface charge n)
surface dipole cancel Δn

Combining, $E = n\Delta + \frac{1}{2} E_{\text{comp}} n^2 - NE_p(1-2n)n + \frac{1}{2} E_D [N(1-2n)]^2$

cost for e^- transfer intralayer repulsion ensure from ΔV dipolar energy cost at
other end of interface

$$\frac{n}{\text{cell}} = \frac{(NE_p + 2N^2 E_D - \Delta)}{E_{\text{comp}} + 4NE_p + 4N^2 E_D}$$

- In experiment



- Classically, $E = \Delta \sum_j n_j + \frac{1}{2} E_c \sum_j n_j^2 + \frac{2\pi e^2}{Ec} \sum_{j=0}^{\infty} \sum_{l=j+1}^{\infty} n_j n_l |j-l|$

Putting all n in 0^{th} layer, $E = n\Delta + \frac{1}{2} E_c n^2$

If we have $n-\delta$ in layer 0, & δ in layer 1

$$\Rightarrow \Delta E = \delta(E_p - E_c)n + O(\delta^2)$$

Thus only delocalized charge if $E_c > E_p$ [hard!]

- ▲ We've neglected e^- hopping, which will produce the desired charge spreading.